AS A BELOW NAMED INVENTOR, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole (if only one name is listed below), or an original, first and joint inventor (if plural names are listed below), of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## INPUT AND OUTPUT CIRCUIT OF SEMICONDUCTOR DEVICE TITLE:

the specification of which either	is attached hereto or indicates an	attorney docket no. 8028-30 (SPX20	<u> 0207-000</u>	<u>4US)</u> , or:
☐ was filed in the U.S. Patent	& Trademark Office on	and assigned Serial No		,
and (if applicable) was ame	nded on			
claims, as amended by any amento patentability and to the exam §1.56. I hereby claim foreign proparent or inventor's certificate than the United States, listed below	Idment referred to above. I acknow ination of this application in accompanity benefits under Title 35, U.S. e. or \$365(a) of any PCT internation	ntents of the above-identified specific whedge the duty to disclose information rdance with Title 37 of the Code of F. Code §119(a)-(d) or §365(b) of any formal application which designated at leasing foreign applications for patent or it is claimed:	on which is Federal Representations oreign applies one countries one cou	s material egulations lication(s) ntry other
2002-58250	Korea	25 September 2002		
(Application Number)	(Country)	(Day/Month/Year filed)		
			Yes [ ]	No [ ]
(Application Number)	(Country)	(Day/Month/Year filed)		

I hereby claim the benefit under Title 35, U.S. Code, §120 of any United States application(s), or §119(e) of any United States provisional application(s), or §365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application(s) in the manner provided by the first paragraph of Title 35, U.S. Code, §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, The Code of Federal Regulations, §1.56(a) which became available between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial Number)	(Filing Date)	(STATUS: patented, pending, abandoned)
(Application Serial Number)	(Filing Date)	(STATUS: patented, pending, abandoned)

I hereby appoint the following attorneys: FRANK CHAU, Reg. No. 34,136; FRANK V. DeROSA, Reg. No. 43,584; NATHANIEL T. WALLACE, Reg. No. 48,909; ERIC M. PARHAM, Reg. No. 45,747; GEORGE D. MORGAN, Reg. No. 46,505; MICHAEL J. PORCO, Reg. No. 46,007; and THOMAS W. McNALLY, Reg. No. 48,609; each of them of F. CHAU & ASSOCIATES, LLP, 1900 Hempstead Turnpike, Suite 501, East Meadow, New York 11554 to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith and with any divisional, continuation, continuation-in-part, reissue or re-examination application, with full power of appointment and with full power to substitute an associate attorney or agent, and to receive all patents which may issue thereon, and request that all correspondence be addressed to:

Frank Chau, Esq. F. CHAU & ASSOCIATES, LLP 1900 Hempstead Turnpike, Suite 501 East Meadow, New York 11554 Area Code: 516-357-0091

HEREBY DECLARE that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 U.S. Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF FIRST OR SOLE INVENTOR: Soon-Kyun SHIN	Citizenship_Korea
1 2/2	- //3 2003
Inventor's signature:  Residence & Post Office Address:  Residence & Post Office Address:  212-901, Hyojachon Donga Apt., Seohy Bundang-gu, Seongnam-city, Gyeonggi- Republic of Korea	
FULL NAME OF SECOND INVENTOR:	Citizenship
Inventor's signature:  Residence & Post Office Address:	Date:
FULL NAME OF THIRD INVENTOR:	Citizenship
Inventor's signature:	Date:
FULL NAME OF FOURTH INVENTOR:	Citizenship
Inventor's signature:	Date:
FULL NAME OF FIFTH INVENTOR:	Citizenship
Inventor's signature:	Date:
FULL NAME OF SIXTH INVENTOR:	Citizenship
Inventor's signature:	Date:
FULL NAME OF SEVENTH INVENTOR:	Citizenship
Inventor's signature:	Date: